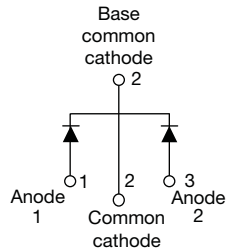
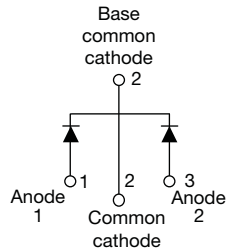


**Ultrafast Rectifier, 2 x 10 A FRED Pt®**

**TO-263AB (D²PAK)**

**VS-MURB2020CTPbF**

**TO-262AA**

**VS-MURB2020CT-1PbF**
**FEATURES**

- Ultrafast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**
**DESCRIPTION / APPLICATIONS**

MUR.. series are the state of the art ultrafast recovery rectifiers specifically designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

| PRODUCT SUMMARY |                            |
|-----------------|----------------------------|
| Package         | TO-263AB (D²PAK), TO-262AA |
| $I_{F(AV)}$     | 2 x 10 A                   |
| $V_R$           | 200 V                      |
| $V_F$ at $I_F$  | 0.85 V                     |
| $t_{rr}$        | 35 ns                      |
| $T_J$ max.      | 175 °C                     |
| Diode variation | Common cathode             |

| ABSOLUTE MAXIMUM RATINGS                    |                |   |             |       |
|---|----------------|---|-------------|-------|
| PARAMETER                                   | SYMBOL         | TEST CONDITIONS                                   | MAX.        | UNITS |
| Peak repetitive reverse voltage             | $V_{RRM}$      |   | 200         | V     |
| Average rectified forward current           | $I_{F(AV)}$    | Rated $V_R$ , $T_C = 145$ °C                      | 10          | A     |
| per leg                                     |                |   | 20          |       |
| total device                                | 100            |   |             |       |
| Non-repetitive peak surge current per leg   | $I_{FSM}$      |   | 100         |       |
| Peak repetitive forward current per leg     | $I_{FM}$       | Rated $V_R$ , square wave, 20 kHz, $T_C = 145$ °C | 20          |       |
| Operating junction and storage temperatures | $T_J, T_{Stg}$ |   | -65 to +175 | °C    |

| ELECTRICAL SPECIFICATIONS ( $T_J = 25$ °C unless otherwise specified) |               |  |      |      |      |         |
|---|---------------|--|------|------|------|---------|
| PARAMETER   | SYMBOL        | TEST CONDITIONS                              | MIN. | TYP. | MAX. | UNITS   |
| Breakdown voltage, blocking voltage                                   | $V_{BR}, V_R$ | $I_R = 100$ $\mu$ A                          | 200  | -    | -    | V       |
| Forward voltage   | $V_F$         | $I_F = 8$ A, $T_J = 125$ °C                  | -    | -    | 0.85 |         |
|   |               | $I_F = 16$ A                                 | -    | -    | 1.15 |         |
|   |               | $I_F = 16$ A, $T_J = 125$ °C                 | -    | -    | 1.05 |         |
| Reverse leakage current   | $I_R$         | $V_R = V_R$ rated                            | -    | -    | 15   | $\mu$ A |
|   |               | $T_J = 150$ °C, $V_R = V_R$ rated            | -    | -    | 250  |         |
| Junction capacitance  | $C_T$         | $V_R = 200$ V                                | -    | 55   | -    | pF      |
| Series inductance   | $L_S$         | Measured lead to lead 5 mm from package body | -    | 8.0  | -    | nH      |



| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) |           |   |      |      |      |       |
|--|-----------|---|------|------|------|-------|
| PARAMETER  | SYMBOL    | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time  | $t_{rr}$  | $I_F = 1.0\text{ A}$ , $dI_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$  | -    | -    | 35   | ns    |
|  |           | $I_F = 1.0\text{ A}$ , $dI_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ | -    | 19   | -    |       |
|  |           | $T_J = 25\text{ }^\circ\text{C}$  | -    | 21   | -    |       |
|  |           | $T_J = 125\text{ }^\circ\text{C}$   | -    | 35   | -    |       |
| Peak recovery current  | $I_{RRM}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 1.9  | -    | A     |
|  |           | $T_J = 125\text{ }^\circ\text{C}$   | -    | 4.8  | -    |       |
| Reverse recovery charge  | $Q_{rr}$  | $T_J = 25\text{ }^\circ\text{C}$  | -    | 25   | -    | nC    |
|  |           | $T_J = 125\text{ }^\circ\text{C}$   | -    | 78   | -    |       |

| <b>THERMAL - MECHANICAL SPECIFICATIONS</b>      |                |  |              |      |      |                           |
|---|----------------|--|--------------|------|------|---------------------------|
| PARAMETER                                       | SYMBOL         | TEST CONDITIONS                            | MIN.         | TYP. | MAX. | UNITS                     |
| Maximum junction and storage temperature range  | $T_J, T_{Stg}$ |  | -65          | -    | 175  | $^\circ\text{C}$          |
| Thermal resistance, junction to case per leg    | $R_{thJC}$     |  | -            | -    | 2.5  | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, junction to ambient per leg | $R_{thJA}$     |  | -            | -    | 50   |                           |
| Thermal resistance, case to heatsink            | $R_{thCS}$     | Mounting surface, flat, smooth and greased | -            | 0.5  | -    |                           |
| Weight  |                |  | -            | 2.0  | -    | g                         |
|   |                |  | -            | 0.07 | -    | oz.                       |
| Mounting torque                                 |                |  | 6.0          | -    | 12   | kgf · cm<br>(lb · in)     |
|   |                |  | (5.0)        | -    | (10) |                           |
| Marking device                                  |                | Case style TO-263AB (D <sup>2</sup> PAK)   | MURB2020CT   |      |      |                           |
|   |                | Case style TO-262AA                        | MURB2020CT-1 |      |      |                           |

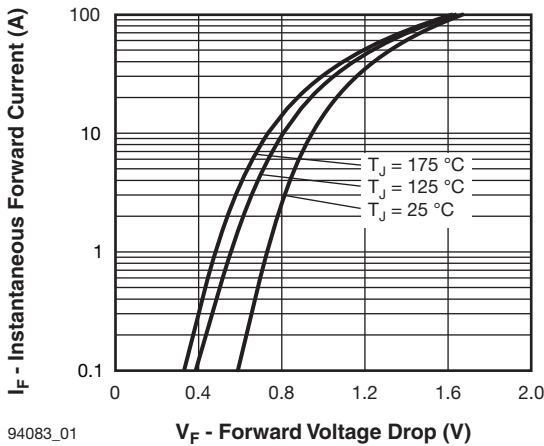


Fig. 1 - Typical Forward Voltage Drop Characteristics

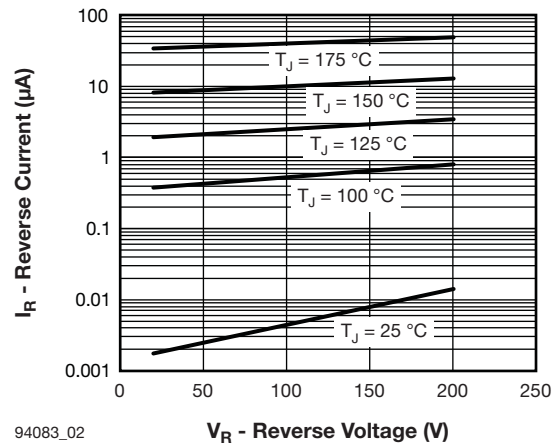


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

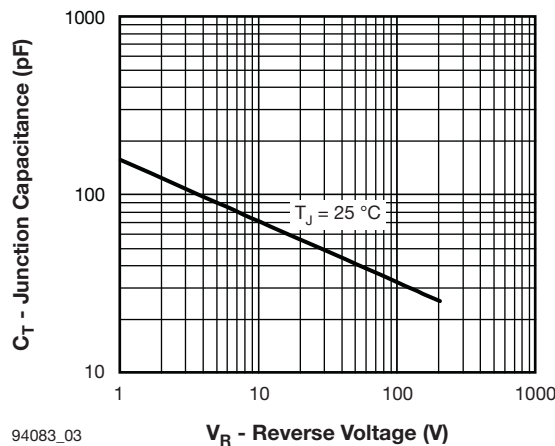


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

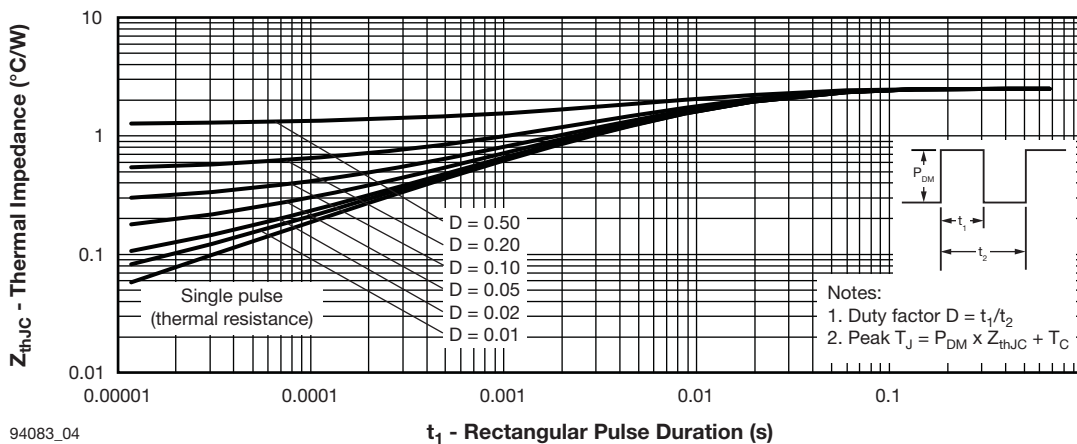
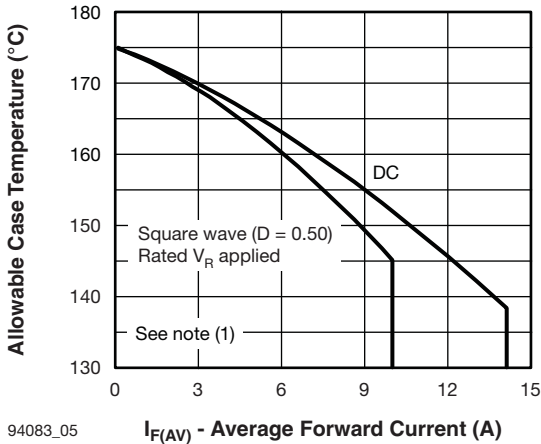
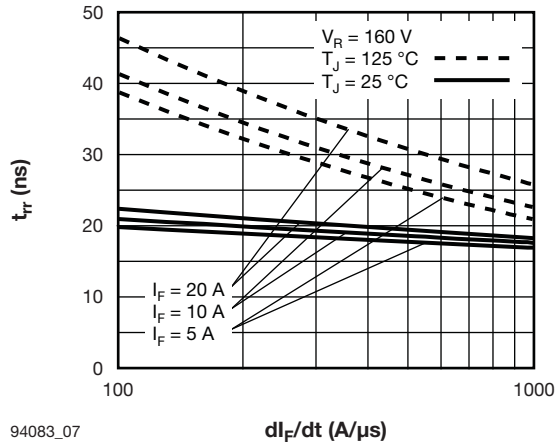


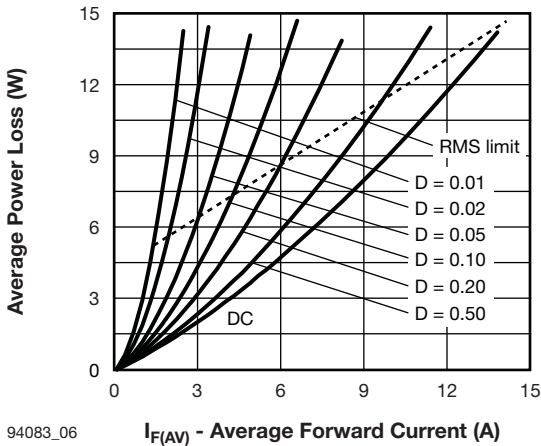
Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics



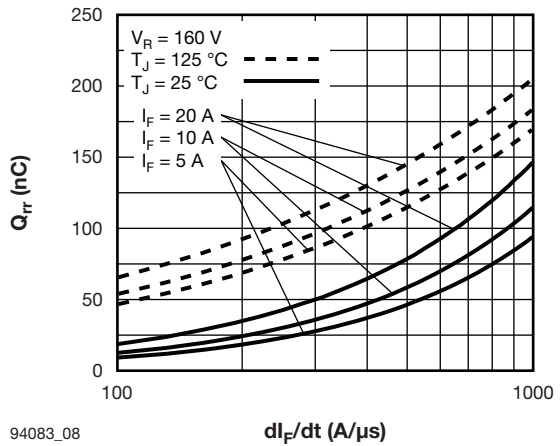
94083\_05  **$I_{F(AV)}$  - Average Forward Current (A)**  
 Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current



94083\_07  **$dI_F/dt$  (A/μs)**  
 Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$



94083\_06  **$I_{F(AV)}$  - Average Forward Current (A)**  
 Fig. 6 - Forward Power Loss Characteristics



94083\_08  **$dI_F/dt$  (A/μs)**  
 Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$

**Note**

- (1) Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;
- $Pd$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);
- $Pd_{REV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$

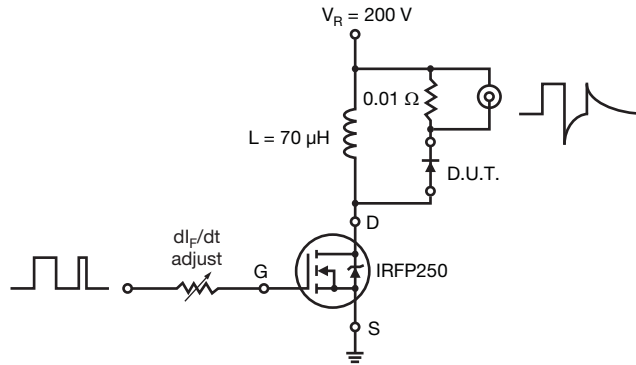
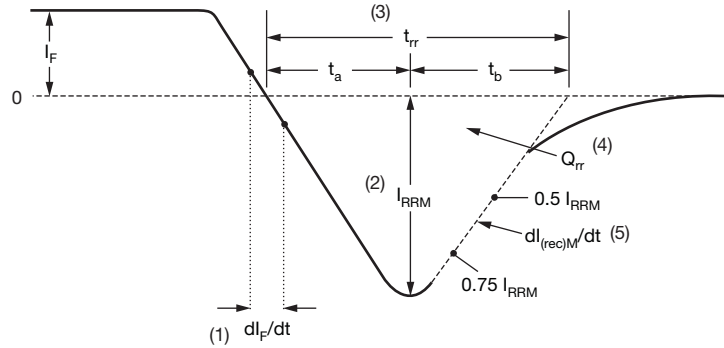


Fig. 9 - Reverse Recovery Parameter Test Circuit



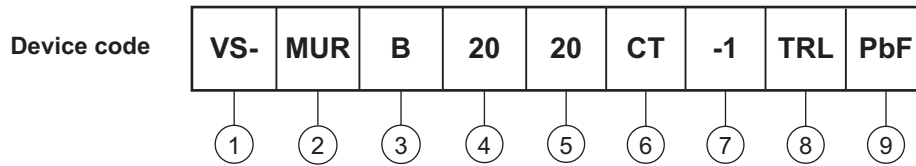
- (1)  $di_F/dt$  - rate of change of current through zero crossing
- (2)  $I_{RRM}$  - peak reverse recovery current
- (3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.
- (4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$
- (5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

Fig. 10 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE



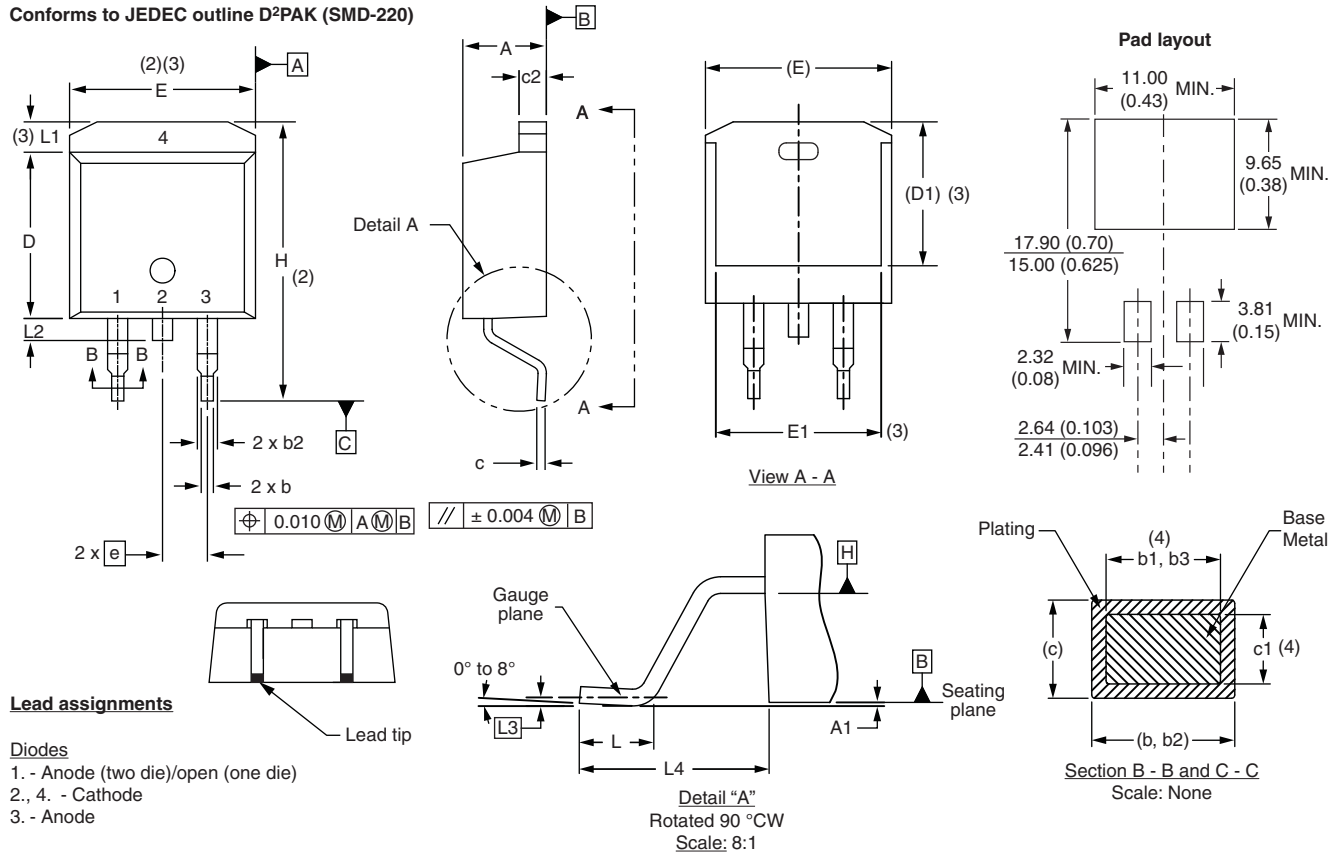
- 1** - Vishay Semiconductors product
- 2** - Ultrafast MUR series
- 3** - B = D<sup>2</sup>PAK/TO-262
- 4** - Current rating (20 = 20 A)
- 5** - Voltage rating (20 = 200 V)
- 6** - CT = center tap (dual) TO-220/D<sup>2</sup>PAK/TO-262
- 7** -
  - -1 = TO-262
  - None = D<sup>2</sup>PAK
- 8** -
  - None = tube (50 pieces)
  - TRL = tape and reel (left oriented, for D<sup>2</sup>PAK package)
  - TRR = tape and reel (right oriented, for D<sup>2</sup>PAK package)
- 9** -
  - PbF = lead (Pb)-free
  - P = lead (Pb)-free (for D<sup>2</sup>PAK TRR and TRL)

| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95014">www.vishay.com/doc?95014</a> |
| Part marking information   | <a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a> |
| Packaging information      | <a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a> |
| SPIICE model               | <a href="http://www.vishay.com/doc?95622">www.vishay.com/doc?95622</a> |

## D<sup>2</sup>PAK, TO-262

### DIMENSIONS - D<sup>2</sup>PAK in millimeters and inches

Conforms to JEDEC outline D<sup>2</sup>PAK (SMD-220)



| SYMBOL | MILLIMETERS |       | INCHES |       | NOTES |
|--------|-------------|-------|--------|-------|-------|
|        | MIN.        | MAX.  | MIN.   | MAX.  |       |
| A      | 4.06        | 4.83  | 0.160  | 0.190 |       |
| A1     | 0.00        | 0.254 | 0.000  | 0.010 |       |
| b      | 0.51        | 0.99  | 0.020  | 0.039 |       |
| b1     | 0.51        | 0.89  | 0.020  | 0.035 | 4     |
| b2     | 1.14        | 1.78  | 0.045  | 0.070 |       |
| b3     | 1.14        | 1.73  | 0.045  | 0.068 | 4     |
| c      | 0.38        | 0.74  | 0.015  | 0.029 |       |
| c1     | 0.38        | 0.58  | 0.015  | 0.023 | 4     |
| c2     | 1.14        | 1.65  | 0.045  | 0.065 |       |
| D      | 8.51        | 9.65  | 0.335  | 0.380 | 2     |

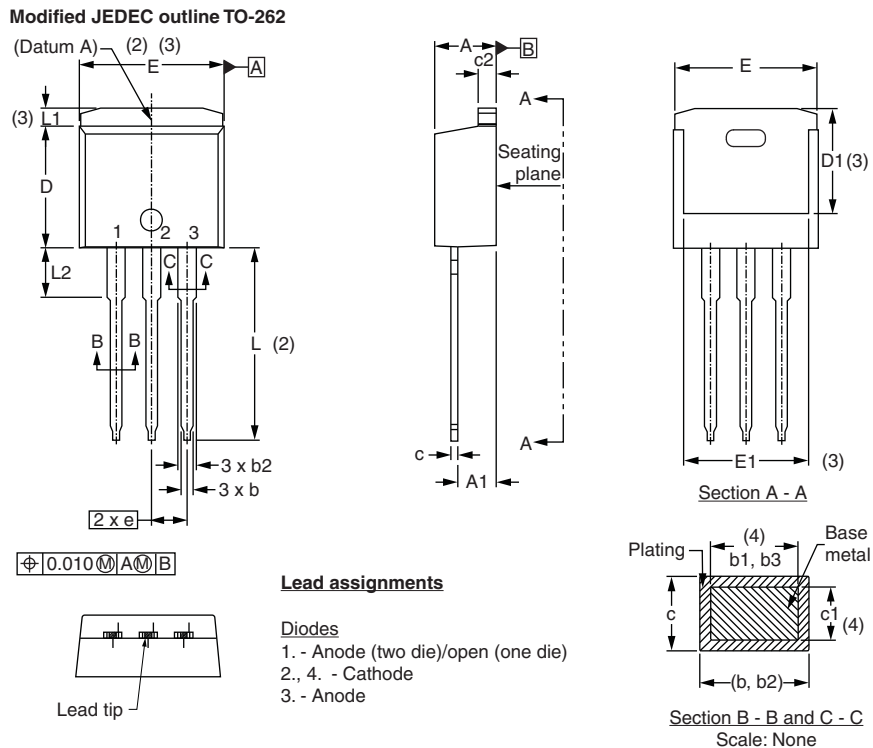
| SYMBOL | MILLIMETERS |       | INCHES    |       | NOTES |
|--------|-------------|-------|-----------|-------|-------|
|        | MIN.        | MAX.  | MIN.      | MAX.  |       |
| D1     | 6.86        | 8.00  | 0.270     | 0.315 | 3     |
| E      | 9.65        | 10.67 | 0.380     | 0.420 | 2, 3  |
| E1     | 7.90        | 8.80  | 0.311     | 0.346 | 3     |
| e      | 2.54 BSC    |       | 0.100 BSC |       |       |
| H      | 14.61       | 15.88 | 0.575     | 0.625 |       |
| L      | 1.78        | 2.79  | 0.070     | 0.110 |       |
| L1     | -           | 1.65  | -         | 0.066 | 3     |
| L2     | 1.27        | 1.78  | 0.050     | 0.070 |       |
| L3     | 0.25 BSC    |       | 0.010 BSC |       |       |
| L4     | 4.78        | 5.28  | 0.188     | 0.208 |       |

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

- (7) Outline conforms to JEDEC outline TO-263AB

## DIMENSIONS - TO-262 in millimeters and inches



| SYMBOL | MILLIMETERS |       | INCHES    |       | NOTES |
|--------|-------------|-------|-----------|-------|-------|
|        | MIN.        | MAX.  | MIN.      | MAX.  |       |
| A      | 4.06        | 4.83  | 0.160     | 0.190 |       |
| A1     | 2.03        | 3.02  | 0.080     | 0.119 |       |
| b      | 0.51        | 0.99  | 0.020     | 0.039 |       |
| b1     | 0.51        | 0.89  | 0.020     | 0.035 | 4     |
| b2     | 1.14        | 1.78  | 0.045     | 0.070 |       |
| b3     | 1.14        | 1.73  | 0.045     | 0.068 | 4     |
| c      | 0.38        | 0.74  | 0.015     | 0.029 |       |
| c1     | 0.38        | 0.58  | 0.015     | 0.023 | 4     |
| c2     | 1.14        | 1.65  | 0.045     | 0.065 |       |
| D      | 8.51        | 9.65  | 0.335     | 0.380 | 2     |
| D1     | 6.86        | 8.00  | 0.270     | 0.315 | 3     |
| E      | 9.65        | 10.67 | 0.380     | 0.420 | 2, 3  |
| E1     | 7.90        | 8.80  | 0.311     | 0.346 | 3     |
| e      | 2.54 BSC    |       | 0.100 BSC |       |       |
| L      | 13.46       | 14.10 | 0.530     | 0.555 |       |
| L1     | -           | 1.65  | -         | 0.065 | 3     |
| L2     | 3.56        | 3.71  | 0.140     | 0.146 |       |

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline





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